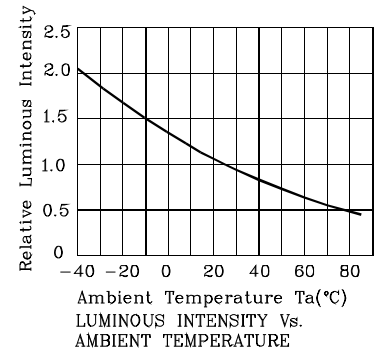
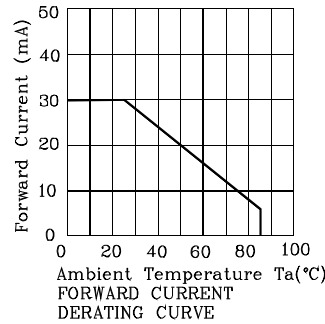
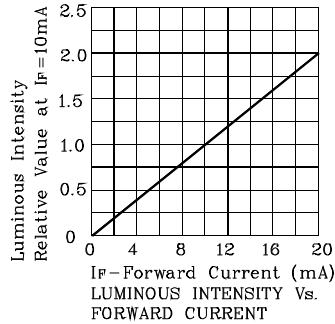
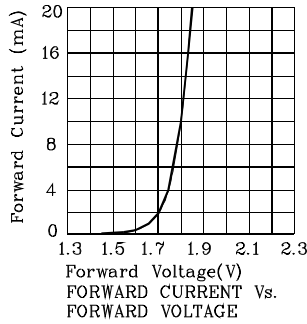
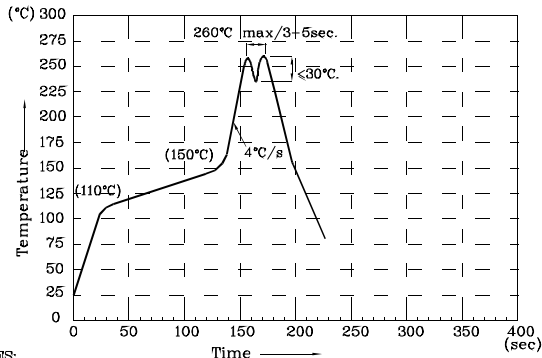


❖ MR



Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- NOTES:
- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
  - 2.Do not apply stress on epoxy resins when temperature is over 85°C.
  - 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
  - 4.During wave soldering, the PCB top-surface temperature should be kept below 105°C.
  - 5.No more than once.

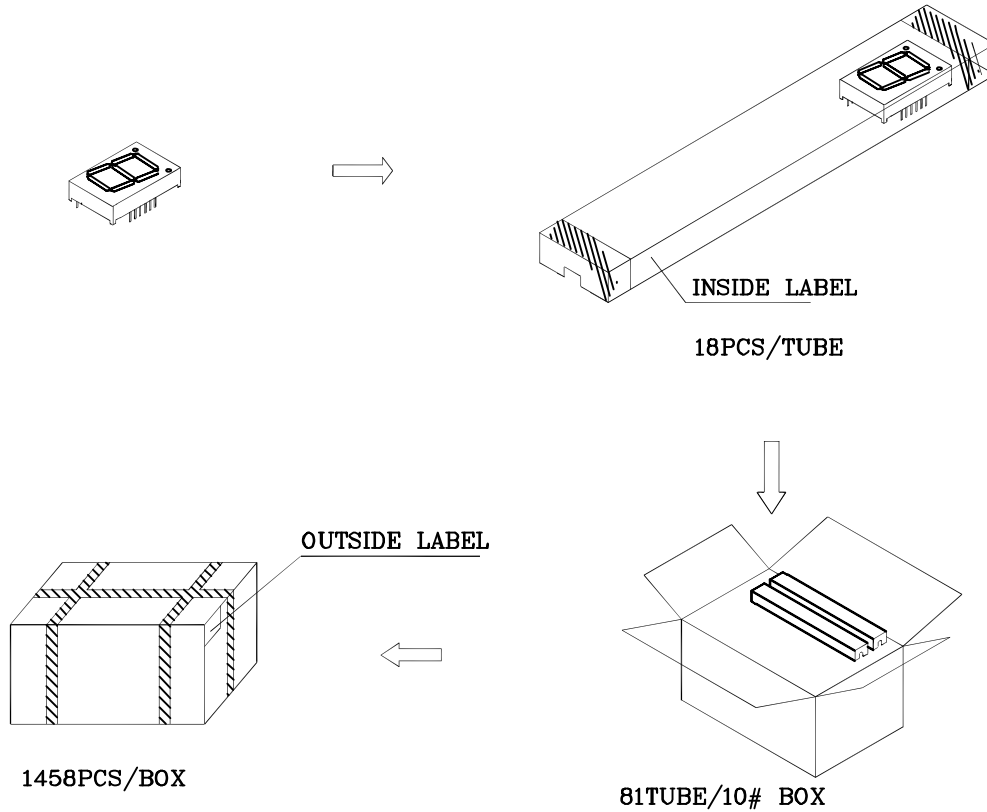
Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

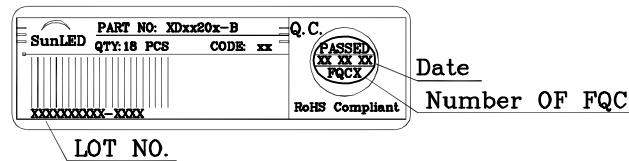
1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS



Inside Label on IC-tube



Outside Label on Box

